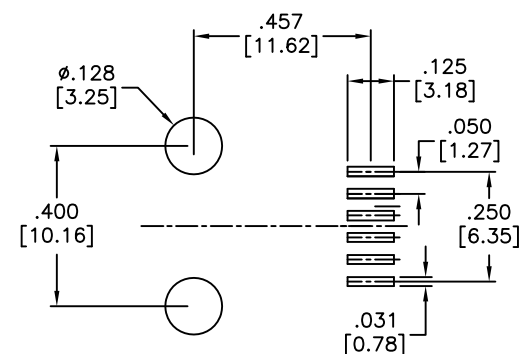
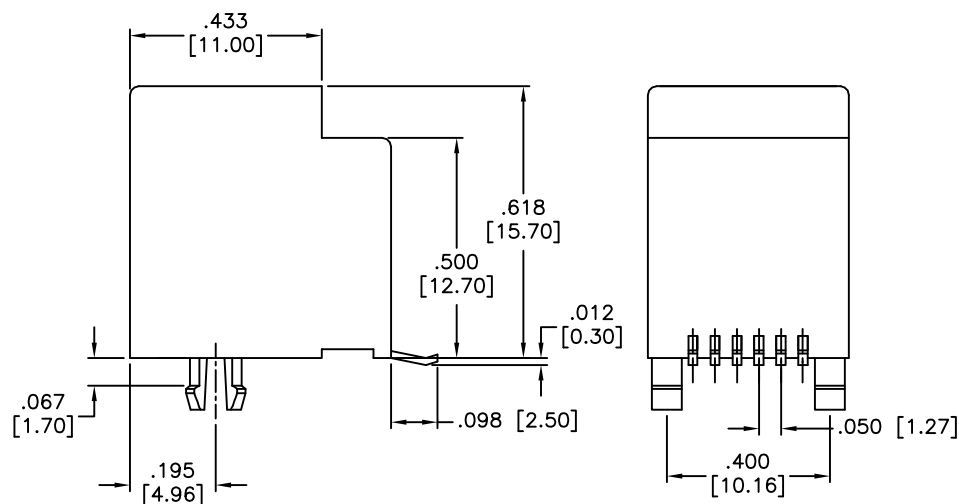
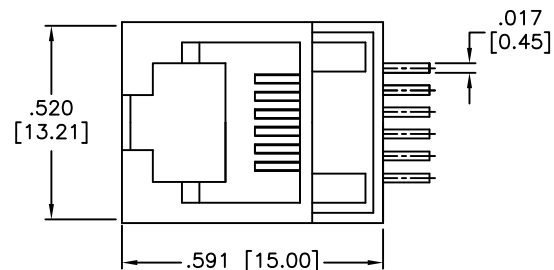


APPROVED: _____

DATE: _____ TITLE: _____

Rev	AWO #	Description	Date	Appr
-	10368	RELEASED	11/20/15	SS
A		ADDEDD PCB LAYOUT PAD DIM	01/05/18	SS



RECOMMENDED PCB LAYOUT
(TOP VIEW)

SPECIFICATIONS:

Material:

Insulator: Hi-temp thermoplastic, rated UL 94V-0

Insulator color: Black

Contacts: Phosphor Bronze

Plating:

Gold over Nickel underplate on contact area,

Tin over Copper underplate on tails.

(See chart for thickness)

Electrical:

Operating voltage: 125 VAC max

Current rating: 1.5 Amps max

Contact resistance: 45 mohms max

Insulation resistance: 1,000 Mohms min @ 500 VDC

Dielectric withstanding voltage: 1000 VAC for 1 minute

Temperature Rating:

Operating temperature: -40°C to +85°C

Environmental:

Lead free, RoHS compliant.



X	PLATING
0	15 µin Gold
1	30 µin Gold
2	50 µin Gold

UNLESS OTHERWISE SPECIFIED
ALL DIMENSIONS ARE INCHES [MM]
TOLERANCES: EXCEPT AS NOTED
INCHES HOLES

.X	± .10	Ø.X	± .10
.XX	± .020	Ø.XX	± .015
.XXX	± .015	Ø.XXX	± .010

APPROVALS		DATE
DRAWN	SS	11/20/15
CHECKED		
APPROVED		



TITLE
MODULAR TELEPHONE JACK, 6P6C
TOP ENTRY, SMT TYPE

SIZE	PART NO.	REV.
X	MTJ-66KX1J	A
REF: S00156T		SCALE: NTS
		SHEET 1 OF 1